

DECLARATION

As a below-named inventor, I declare that:

my residence, post office address, and citizenship are as stated next to my name;

I believe that I am an original inventor of the invention entitled "Semiconductor Integrated Circuit Device Comprising Synchronous DRAM Core And Logic Circuit Integrated Into A Single Chip And Method Of Testing The Synchronous DRAM Core" described and claimed in the attached specification;

I have reviewed and understand the contents of the specification, including the claims;

I acknowledge the duty to disclose information that is material to the examination of this application in accordance with 37 C.F.R. §1.56(n); and

I hereby claim foreign priority benefits under Title 35, United States Code §119 of the foreign application for patent listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application from which the benefit of priority is claimed.

Prior Foreign Application

(Number)	(Country)	(Day/Month/Year Filed)
9-086600	Japan	04/04/97

United States Patent 5,910,181, which matured from United States Patent Application Serial Number 08/964,236, is partly inoperative or invalid by reason of claiming less than I had a right to claim based on the disclosure of the patent application. The patent application disclosure does not limit the invention to a synchronous dynamic random access memory but discloses the invention as pertaining to other kinds of random access memory particularly as described at column 13, lines 62-65 of United States Patent 5,910,181. In addition, minor errors of a grammatical or typographical nature appear in claims 5, 6, 7, and 9 of U. S. Patent 5,910,181.

To the best of my knowledge, the errors occurred without deceptive intent. Correction of the errors is sought by correcting claims 5, 6, 7, and 9 and by adding claims 10-18 as shown in the attached papers.

I appoint:

John M. Belz, Registration Number 30,359,
Jeffrey A. Wyand, Registration Number 29,458,
Jeremy M. Jay, Registration Number 33,587,
Xavier Pillai, Registration No. 39,799,
Leah Oubre, Registration No. 44,990, and
Shannon Schemmel, Registration No. 47,926.

my attorneys with full power of substitute and revocation to prosecute my application for reissue of my Letters Patent and to transact all business in the United States Patent and Trademark Office connected with that application.

I further direct that correspondence concerning this application be directed to:

Leydig, Voit & Mayer
700 Thirteenth Street, N. W.
Suite 300
Washington, D. C. 20005.

I declare that all statements made here based on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of this reissue patent application or any reissued patent issuing from this application.

Full name of first inventor:

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